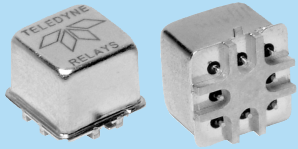




A Unit of Teledyne Electronics and Communications

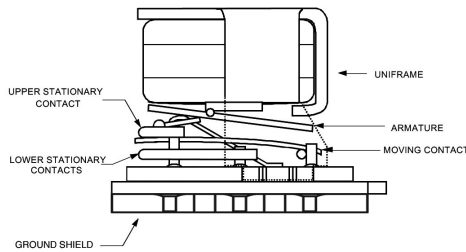
SURFACE MOUNT, HIGH REPEATABILITY, BROADBAND CENTIGRID® RELAYS DPDT

SERIES GRF100 GRF103



SERIES DESIGNATION	RELAY TYPE
GRF100	Repeatable, RF Centigrd® relay
GRF103	Sensitive, repeatable, RF Centigrd® relay

INTERNAL CONSTRUCTION



DESCRIPTION

The ultraminiature GRF100 and GRF103 relays are designed to provide a practical surface-mount solution with improved RF signal repeatability over the frequency range. GRF100 and GRF103 relays feature a unique ground shield that isolates and shields each lead to ensure excellent contact-to-contact and pole-to-pole isolation. This ground shield provides a ground interface that results in improved high-frequency performance as well as parametric repeatability. The GRF100 and GRF103 extend performance advantages over similar RF devices that simply offer formed leads for surface mounting.

These relays are engineered for use in RF attenuator, RF switch matrices, ATE and other applications that require dependable high frequency signal fidelity and performance.

The GRF100 and GRF103 feature:

- High repeatability
- Broader bandwidth
- Metal enclosure for EMI shielding
- High isolation between control and signal paths
- High resistance to ESD

The following unique construction features and manufacturing techniques provide excellent robustness to environmental extremes and overall high reliability:

- Uniframe motor design provides high magnetic efficiency and mechanical rigidity
- Minimum mass components and welded construction provide maximum resistance to shock and vibration
- Advanced cleaning techniques provide maximum assurance of internal cleanliness
- Gold-plated precious metal alloy contacts ensure reliable switching
- Hermetically sealed

ENVIRONMENTAL AND PHYSICAL SPECIFICATIONS

Temperature (Ambient)	Storage	-65°C to +125°C
	Operating	-55°C to +85°C
Vibration (General Note 1)		10 g's to 500 Hz
Shock (General Note 1)		30 g's, 6 msec, half-sine
Enclosure		Hermetically sealed
Weight	GRF100	0.09 oz. (2.55g) max.
	GRF103	0.16 oz. (4.5g) max.

**SERIES GRF100 GRF103
GENERAL ELECTRICAL SPECIFICATIONS (@25°C)**

Contact Arrangement	DPDT	
Rated Duty	Continuous	
Contact Resistance	0.100 ohm max.	
Contact Load Rating	Low Level: 10 to 50 μ A/10 to 50mV	
Contact Life Rating	10,000,000 cycles (typical) at low level	
Coil Operating Power	GRF100-5: 500 mW typical @ nominal rated voltage	GRF100-12: 369 mW typical @ nominal rated voltage
	GRF103-5: 250 mW typical @ nominal rated voltage	GRF103-12: 180 mW typical @ nominal rated voltage
Operate Time	GRF100	4.0 msec max.
	GRF103	6.0 msec max.
Release Time	GRF100	3.0 msec max.
	GRF103	3.0 msec max.
Intercontact Capacitance	0.4 pf typical	
Insulation Resistance	1,000 megohms min. between mutually isolated terminals	
Dielectric Strength	350 Vrms/60Hz @ atmospheric pressure	

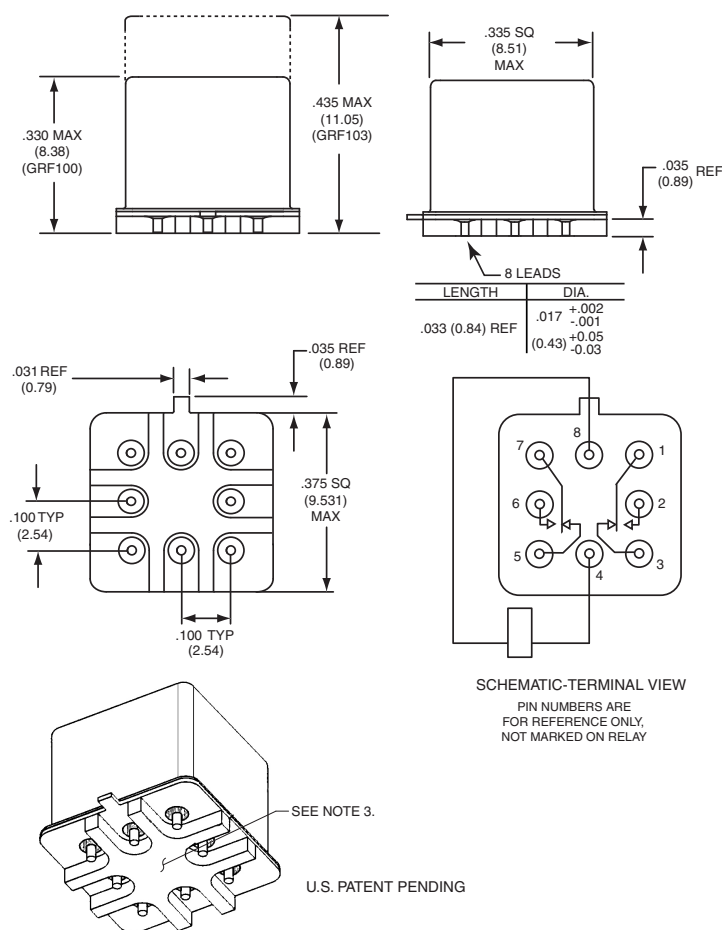
DETAILED ELECTRICAL SPECIFICATIONS (@25°C)

	BASE PART NUMBERS	GRF100-5	GRF100-12
		GRF103-5	GRF103-12
Coil Voltage, Nominal (Vdc)		5.0	12.0
Coil Resistance (Ohms \pm20%)	GRF100	50	390
	GRF103	100	800
Pick-up Voltage (Vdc, Max.)		3.6	9.0

GENERAL NOTES

1. Relays will exhibit no contact chatter in excess of 10 μ sec or transfer in excess of 1 μ sec.
2. Unless otherwise specified, parameters are initial values.
3. Relays may be subjected to 260°C, peak solder reflow temperature, 1 minute, 3 passes.
4. Butt-lead ends are coplanar within .003" (0.08).
5. Application notes available for PCB layout and mounting information.

OUTLINE DIMENSIONS



NOTES:
 1. DIMENSIONS ARE IN INCHES. METRIC EQUIVALENTS IN MILLIMETERS ARE SHOWN IN ().
 2. UNLESS OTHERWISE SPECIFIED, TOLERANCES ON DIMENSIONS ARE .010 INCH (0.025 mm).
 3. FOR OPTIMAL RF PERFORMANCE, SOLDER BOTTOM OF GROUND SHIELD TO PCB RF GROUND PLANE.